

AMENDMENTS TO THE CLAIMS

Please cancel claims 1-13 without prejudice and add claims 14-27 as follows:

Claims 1-13 (Cancelled)

14. (New) An article of manufacture comprising:

a substrate; and

an optoelectronic component,

wherein the optoelectronic component is contacted in a planar manner.

15. (New) The article of manufacture according to claim 1, wherein the substrate has a conducting element with which the optoelectronic element is contacted in a planar manner.

16. (New) The article of manufacture according to claim 15, wherein the conducting element is a printed conductor.

17. (New) The article of manufacture according to claim 14, wherein the substrate and/or the optoelectronic component are at least partially provided with an

insulating layer , on which a planar conducting structure is disposed for planar contacting of the optoelectronic component.

18. (New) The article of manufacture according to claim 17, wherein the insulating layer comprises one or more of a foil, enamel, and a polymer layer.

19. (New) The article of manufacture according to claim 17, wherein the insulating layer is transparent in the area of a light exit and/or entry opening of the optoelectronic component.

20. (New) The article of manufacture according to claim 17, wherein a window is opened in the insulating layer in the area of a light exit and/or entry opening of the optoelectronic component.

21. (New) The article of manufacture according to claim 17, wherein in the insulating layer in the area of a contact point for the optoelectronic component a window is opened through which the planar conducting structure is led to the contact point of the optoelectronic component.

22. (New) The article of manufacture according to claim 17, wherein the insulating layer contains pigments to color the light emitted from or absorbed by the optoelectronic component.

23. (New) The article of manufacture according to claim 14, wherein the planar contact at least partially covers a light exit and/or entry opening of the optoelectronic component.

24. (New) The article of manufacture according to claim 14, wherein the optoelectronic component comprises one or more of an LED, an OLED, and a photovoltaic component.

25. (New) The article of manufacture according to claim 14, wherein the substrate is one of: a printed circuit board, a Flex, and a lead frame.

26. (New) The article of manufacture according to claim 14, wherein the height of the article of manufacture is less than 0.4 mm.

27. (New) A method of making an article of manufacture comprising a substrate and an optoelectronic component, the method comprising contacting the optoelectronic component in a planar manner.

28. (New) An article of manufacture comprising:

a substrate having a substrate contact;

an optoelectronic component, said optoelectronic component having a central light exit and an edge contact disposed at least partially around a periphery of the light exit; and

a conducting structure, arranged on the optoelectronic component and the substrate so as to contact the edge contact and the substrate contact.

29. (New) The article of manufacture according to claim 28, further comprising an electrically insulating layer contacting the optoelectronic component, on which the planar conducting structure is disposed.

30. (New) The article of manufacture according to claim 29, wherein the electrically insulating layer has a window formed in an area of the light exit.

31. (New) The article of manufacture according to claim 29, wherein the electrically insulating layer has transparent portion formed in an area of the light exit.

32. (New) The article of manufacture according to claim 28, wherein the conducting structure is a metallic layer.